

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of)	MAIL STOP AMENDMENT
Hiroshi UEHARA et al.)	Group Art Unit: 1713
Application No.: 10/511,826)	Examiner: Mei Qi HUANG
Filed: October 20, 2004)	Confirmation No.: 8838
For: THERMOPLASTIC RESIN COMPOSITION, POLYMER COMPOSITION, AND MOLDED OBJECT)	

AMENDMENT AND SUBMISSION OF FOURTH INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated January 6, 2006, please amend the aboveidentified patent application as follows: